

#2 / Pre-Amend A  
4-18-02  
Juo

PATENT  
Customer No. 22,852  
Attorney Docket No. 7447.0021-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
)  
Jeng Ping LU et al. ) Group Art Unit: Unknown  
)  
Rule 53(b) Divisional of Prior Application: ) Examiner: Unknown  
Serial No. 09/419,293, filed 10/15/99 )  
)  
Serial No.: Not Yet Assigned )  
)  
For: DUAL DIELECTRIC STRUCTURE )  
FOR SUPPRESSING LATERAL )  
LEAKAGE CURRENT IN HIGH )  
FILL FACTOR ARRAYS )

Commissioner for Patents and Trademarks  
Washington, DC 20231

Sir:

**PRELIMINARY AMENDMENT**

Prior to the examination of the above application, please amend this application  
as follows:

**IN THE CLAIMS:**

Please cancel claims 1-6, without prejudice or disclaimer of the subject matter,  
and add new claims 11-15, as follows:

11. (New) A high fill factor image array formed by:  
providing a plurality of source-drain metal contacts;  
depositing a first passivation layer;  
depositing a second passivation layer over the first passivation layer that  
suppresses lateral leakage current;

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Sub  
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